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SDLS172 OCTOBER 1976 - REVISED MARCH 1988

- Three-State, 4 Bit, Cascadable, Parallei-In, Parallei-Out Registers
- 'LS395A Offers Three Times the Sink-Current Capability of 'LS395
- Low Power Dissipation . . . 75 mW Typical (Enabled)
- Applications:

N-Bit Serial-To-Parallel Converter N-Bit Parallel-To-Serial Converter

N-Bit Storage Register

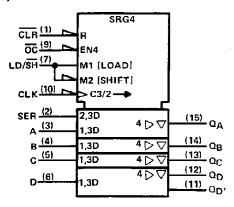
description

These 4-bit registers feature parallel inputs, parallel outputs, and clock (CLK), serial (SER), load shift (LD/ $\overline{\rm SH}$), output control ($\overline{\rm OC}$) and direct overriding clear ($\overline{\rm CLR}$) inputs.

Shifting is accomplished when the load/shift control is low. Parallel loading is accomplished by applying the four bits of data and taking the load/shift control input high. The data is loaded into the associated flip-flops and appears at the outputs after the high-to-low transition of the clock input. During parallel loading, the entry of serial data is inhibited.

When the output control is low, the normal logic levels of the four outputs are available for driving the loads or bus lines. The outputs are disabled independently from the level of the clock by a high logic level at the output control input. The outputs then present a high impedance and neither load nor drive the bus line; however, sequential operation of the registers is not affected. During the high-impedance mode, the output at Qp' is still available for cascading.

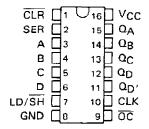
logic symbol†



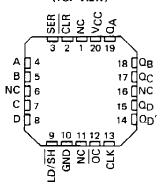
[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN54LS395A . . . J OR W PACKAGE SN74LS395A . . . D OR N PACKAGE (TOP VIEW)



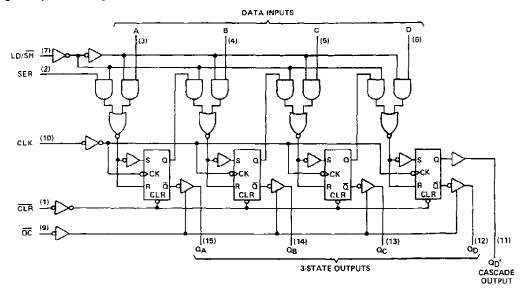
SN54LS395A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

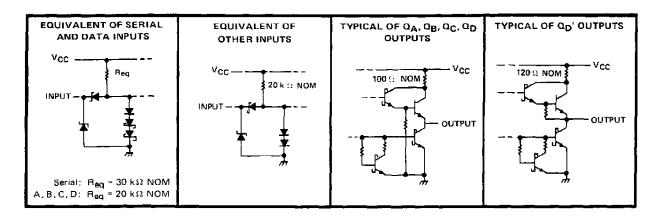


logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.

schematics of inputs and outputs



FUNCTION TABLE

	INPUTS									3-STATE OUTPUTS							
CLR	LD/SH	CLK	SER	PΔ	PARALLE		PARALLEL			_	_			OUTPUT			
CLN	LD/SH	CLK	SEH	Α	8	С	D	QΑ	σB	чc	αD	α _D ′					
L	×	×	×	Х	Х	Х	Х	L	L	L	L	L					
н	н	[н	×	×	X	х	х	QAO	σ_{B0}	q_{C0}	α_{D0}	σ _{D0}					
н	н	ı	х	а	ь		d	a	ь	С	d	d					
н	L	н	×	X	х	х	х	QAO	080	α_{C0}	a _{D0}	α_{D0}					
н	L	ı.	H				X		q_{An}			σ_{Cu}					
н	L	1	L	х	Х	Х	Х	L	α_{An}	α_{Bn}	Q _{Cn}	a _{Cn}					

When the output control is high, the 3-state outputs are disabled to the high-impedance state; however, sequential operation of the registers and the output at Q_D' are not affected.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)																			7	7 V
Input voltage																			7	7 V
Operating free-air temperature range	: SI	N54	4 L	\$3	95/	À.							-			6	55°	C to	125	°C
	SI	N74	4L	S3	95 <i>A</i>	4				÷							0	°C 1	to 70)°C
Storage temperature range											_					6	65°	C to	150)°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		Sh	154LS39	95A	SN				
· · · · · · · · · · · · · · · · · · ·		MIN	NOM	MAX	MIN	NOM	MAX	דומט	
Supply voltage, VCC		4.5	5	5.5	4.75	5	5.25	V	
High-level output current, IOH	Q _A , Q _B , Q _C , Q _D			-1			-2.6	mA	
				-400			-400	μА	
Low-level output current To:	QA, QB, QC, QD			12			24	mΑ	
ow-level output current, IOL	QD'			4	_	,	8	mA	
Clock frequency, f _{clock}	·	0		30	0		30	MHz	
Width of clock pulse, tw(clock)		16			16			ns	
Setup time, high-level or low-level data, t _{su}	LD/SH	40		•	40				
Setup time, mightered of fow-level data, t _{SU}	All other inputs	20			20		5 5.25 -2.6 -400 24 8 30	ns	
Hold time, high-level or low-level data, th		10		**	10			ns	
Operating free-air temperature, TA		-55	******	125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

BAD AMETER		750	SI	V54LS39	95A	SI	1				
	PARAMETER	162	T CONDITION	181	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage				2			2			٧
VIL	Low-level input voltage						0.7			0.8	V
VIK	Input clamp voltage	VCC = MIN,	I _I = -18 mA				-1.5			-1,5	٧
∨он	High-level output voltage	VCC = MIN,	V _{IH} = 2 V,	QA, QB, QC, QD	2.4	3.4		2.4	3.1		V
	. •	ViL≂ViLmax,	IOH = MAX	Q _D ′	2.5	3.4		2.7	3.4		V
		V _{CC} = MIN,	QД, QВ,	IOL = 12 mA		0.25	0.4		0.25	0.4	v
	Low-level output voltage	V _{CC} = WHV, V _{IL} = V _{IL} max, V _{IH} = 2 V	a_{C}, a_{D}	I _{OL} = 24 mA			-		0.35	0.5	1 °
VOL			$\mathfrak{a}_{D'}$	IOL = 4 mA		0.25	0.4		0.25	0.4	V
		VIH - 2 V	α υ	IOL = 8 mA					0.35	0.5	L
1	Off-state output current,	V _{CC} = MAX,	V _{IH} = 2 V,	Q _A , Q _B ,			20			20	μА
IOZH	high-level voltage applied	Vo = 2.7 V		ac, an			20				
lozu	Off-state output current,	VCC = MAX,	V _{IH} = 2 V,	QA, QB,			-20			-20	μΑ
IOZL	low-level voltage applied	Vo = 0.4 V		ac, ap							
I _I	input current at maximum input voltage	V _{CC} = MAX,	V ₁ = 7 V				0.1			0.1	mA
hн	High-level input current	V _{CC} = MAX,	V ₁ = 2.7 V				20			20	μА
TIL	Low-level input current	VCC = MAX,	VI = 0.4 V	·			-0.4			-0.4	mA
los	Short-circuit output current§	V _{CC} ≈ MAX		Q _A , Q _B , Q _C , Q _D	-30		-130	-30		-130	mA
	·	_		QD'	-20		-100	-20		-100	mA
	D)/ ## 6 V	San Nana 2	Condition A		22	34		22	34	^
ICC	Supply current	VCC = MAX,	See Note 2	Condition B		21	31		21	31	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

- A. Output control at 4.5 V and a momentary 3 V, then ground, applied to clock input.
- B. Output control and clock input grounded.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
fmax	Maximum clock frequency	See Note 3.	30	45		MHz
tPHL	Propagation delay time, high-to-low-lavel output from clear			22	35	กร
tPLH	Propagation delay time, low-to-high-level output	Ω_A , Ω_B , Ω_C , Ω_D outputs: $R_1 = 667 \Omega$, $C_1 = 45 pF$		15	30	ns
tPHL	Propagation delay time, high-to-low-level output			20	30	ns.
†PZH	Output enable time to high level	Ω_D output: $R_1 = 2 k\Omega, C_1 = 15 pF$		15	25	ns
tPZL	Output enable time to low level			17	25	ns
^t PHZ	Output disable time from high level	C _L = 5 pF,		11	17	ns
^t PLZ	Output disable time from low level	See Note 3	_	12	20	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

[§] Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2: ICC is measured with the outputs open, the serial input and mode control at 4.5 V, and the data inputs grounded under the following conditions:

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